

Part Change Notice: SF53 Series Cover Plating Specification Change

JAE will modify the cover plating of part number SF53 Series micro SIM connector. A nickel base plating will be added under the current gold plating. JAE has validated that solderability and mechanical solder strength is unaffected by this update.

1. Applicable Product:

| Part Number |
|------------------|
| SF53S006VCBR2000 |

2. Modification Details:

Nickel base plating will be added on the soldering areas.

| | |
|---------------|----------------------------------|
| Before | No base plating, just Au plating |
| After | Ni base plating, Au plating |

3. Schedule:

Parts with the new plating will start shipping at the beginning of October. If a customer requires additional validation test data, please contact JAE.

If you have any questions regarding this matter, please contact your JAE account manager.
Thank you for your cooperation.

